

MJE13003DGT

Rev.E Mar.-2016

描述 / Descriptions

SOT-89 塑封封装 NPN 半导体三极管。Silicon NPN transistor in a SOT-89 Plastic Package.

特征 / Features

快速转换。

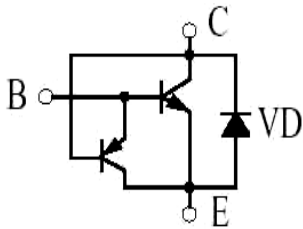
High Speed Switching

用途 / Applications

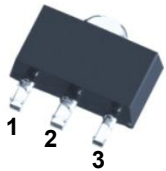
主要用于节能灯、日光灯电子镇流器及其它开关、振荡电路。

High frequency electronic lighting ballast applications, converters, inverters switching , regulators, etc.

内部等效电路 / Equivalent Circuit



引脚排列 / Pinning



PIN1 : Base

PIN 2 : Collector

PIN 3 : Emitter

印章代码 / Marking

Marking

H03G *
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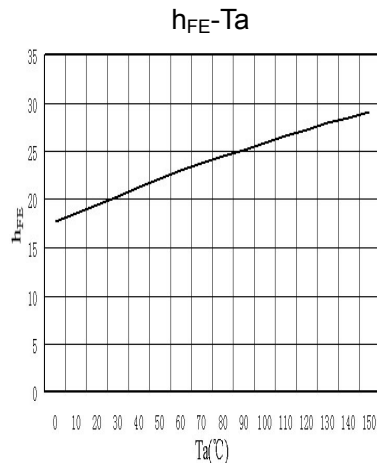
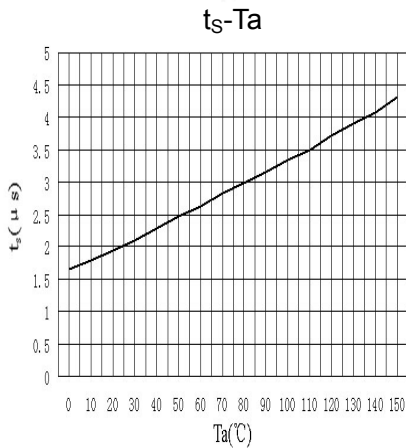
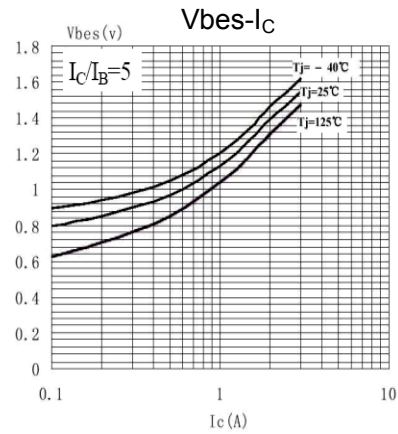
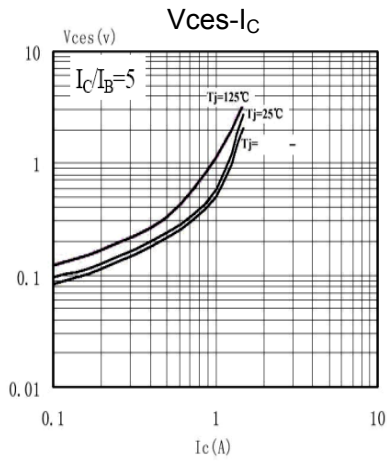
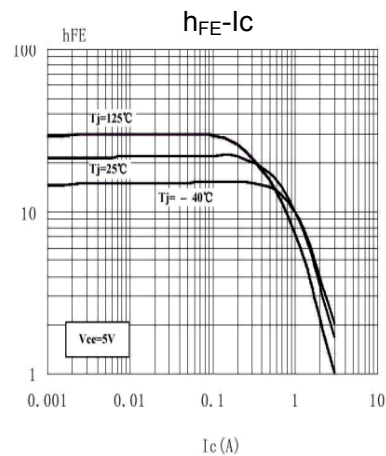
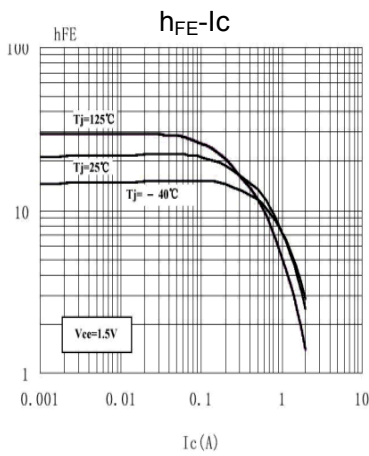
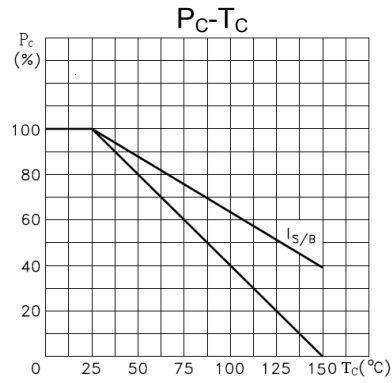
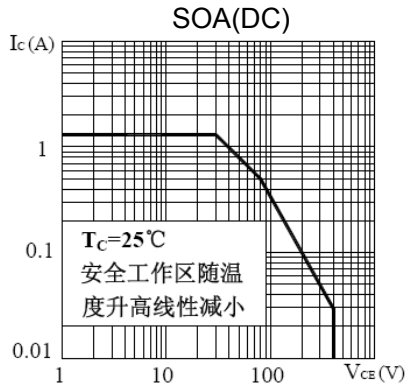
极限参数 / Absolute Maximum Ratings(Ta=25°C)

参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Collector to Base Voltage	V_{CBO}	600	V
Collector to Emitter Voltage	V_{CEO}	400	V
Emitter to Base Voltage	V_{EBO}	9.0	V
Collector Current - Continuous	I_C	1.3	A
Collector Power Dissipation	$P_C(Ta=25^\circ C)$	1.0	W
Junction Temperature	T_j	150	°C
Storage Temperature Range	T_{sag}	-55~150	°C

电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Collector-Base Voltage	V_{CBO}	$I_C=1mA$ $I_E=0$	600			V
Collector-Emitter Voltage	V_{CEO}	$I_C=10mA$ $I_B=0$	400			V
Emitter-Base Voltage	V_{EBO}	$I_E=1mA$ $I_C=0$	9.0			V
Collector Cut-Off Current	I_{CBO}	$V_{CB}=600V$ $I_E=0$			0.1	mA
Collector cut-off current	I_{CEO}	$V_{CE}=400V$ $I_B=0$			0.1	mA
Emitter Base Cut-Off Current	I_{EBO}	$V_{EB}=9.0V$ $I_C=0$			0.1	mA
DC Current Gain	$h_{FE(1)}$	$V_{CE}=5V$ $I_C=200mA$	10		40	
	$h_{FE(2)}$	$V_{CE}=5V$ $I_C=1mA$	7			
	$h_{FE(3)}$	$V_{CE}=5V$ $I_C=1.2A$	5			
Collector to Emitter Saturation Voltage	$V_{CE(sat)(1)}$	$I_C=500mA$ $I_B=100mA$			0.5	V
	$V_{CE(sat)(2)}$	$I_C=1.0A$ $I_B=500mA$			0.6	V
Base to Emitter Saturation Voltage	$V_{BE(sat)}$	$I_C=500mA$ $I_B=100mA$			1.2	V
Fall time	t_f	$V_{CE}=5V$ (U19600) $I_C=0.25A$			0.8	μS
Storage time	t_s				3.5	μS
Transition Frequency	f_T	$V_{CE}=10V$ $f=1MHz$ $I_C=0.1A$	5			MHz

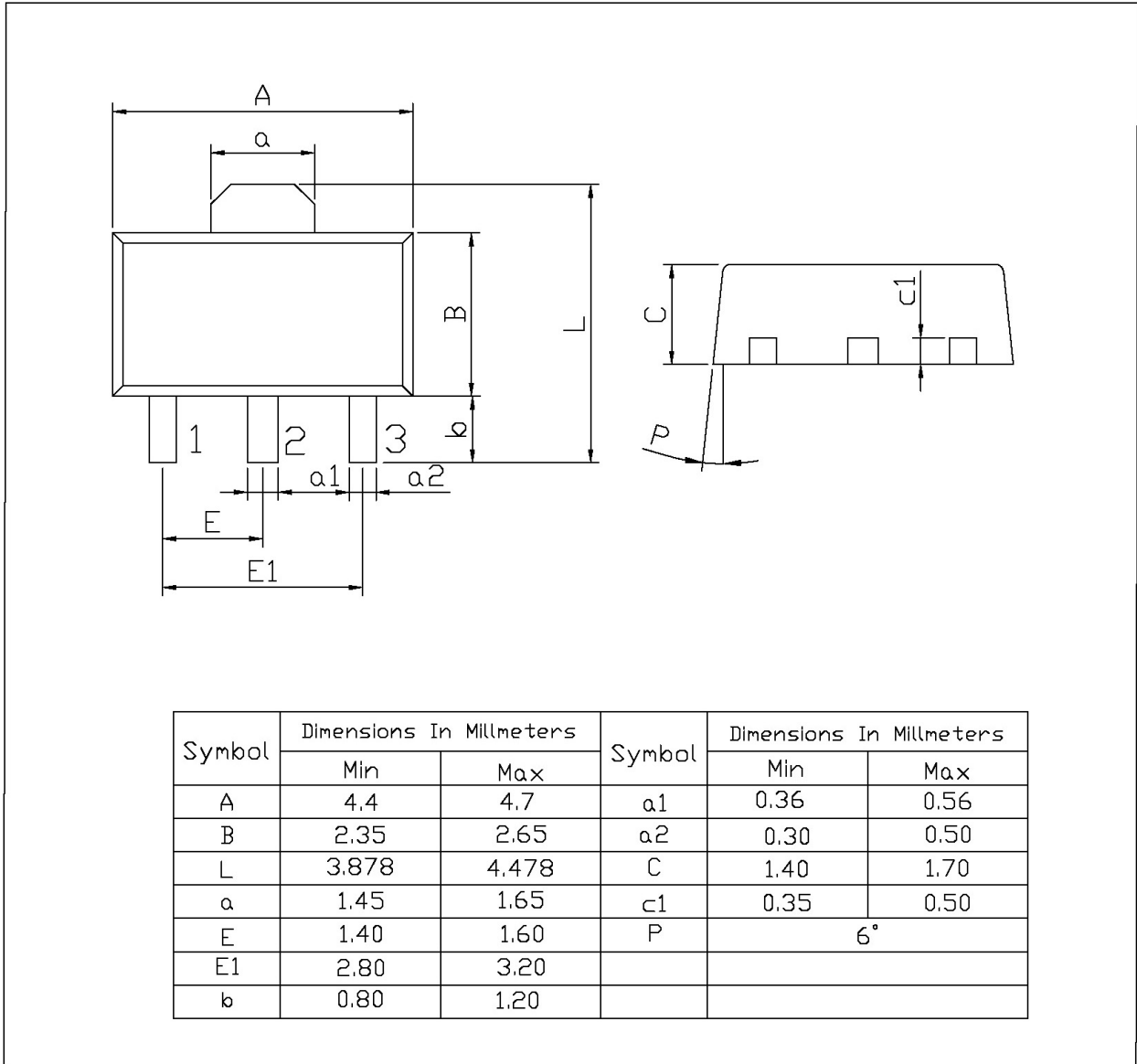
电参数曲线图 / Electrical Characteristic Curve



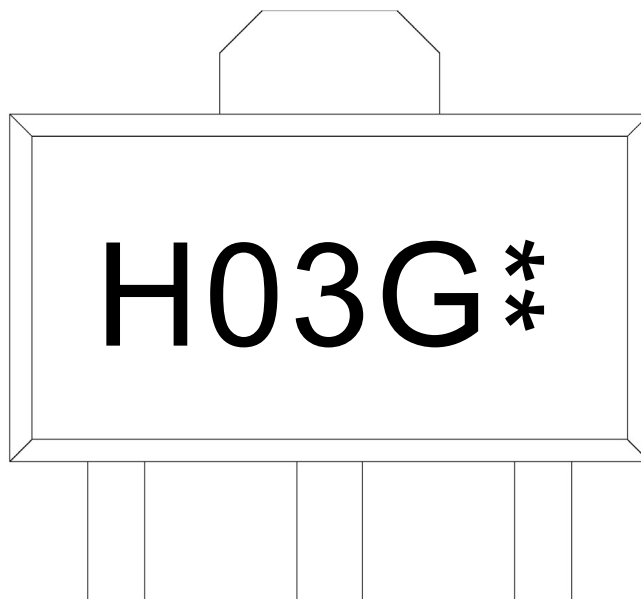
外形尺寸图 / Package Dimensions

SOT-89

单位: mm



印章说明 / Marking Instructions



说明：

H： 为公司代码

03G： 为型号代码

**： 为生产批号代码，随生产批号变化

Note:

H: Company Code.

03G: Product Type.

** : Lot No. Code, code change with Lot No.

回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)



说明：

- 1、预热温度 25~150°C，时间 60~90sec;
- 2、峰值温度 245±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2~10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-89	1,000	7	7,000	8	56,000	7" ×12	180×120×180	385×257×392

使用说明 / Notices